

INFORMATION DISCLOSURE STATEMENT	Atty. Docket No.: 55114USA8A002	Serial No.: 09/412,772 09/916,063
	Applicant(s): Richard W. Anderson and John L. Vandenberg	
	Filing Date: October 4, 1999	Group: 1772

U.S. PATENT DOCUMENTS

Examiner Initial	Document Number	Date	Name	Class	SubClass	Filing Date If Appropriate
MPV	4,588,258	5/13/86	Hoopman			
	4,775,219	10/04/88	Appeldorn et al.			
	4,895,428	01/23/90	Nelson et al.			
	5,122,902	06/16/92	Benson			
	5,138,488	08/11/92	Szczec			
	5,450,235	09/12/95	Smith et al.			
	5,763,049	06/09/98	Frey et al.			
	5,770,124	06/23/98	Marecki et al.			
	5,814,355	09/29/98	Shusta et al.			
	5,840,405	11/24/98	Shusta et al.			
MPV	5,948,488	09/07/99	Marecki et al.			

FOREIGN PATENT DOCUMENTS

	Document Number	Date of Publication	Country	Class	SubClass	Translation	
						Yes	No
MPV	JP55030941	03/05/80	Patent Abstracts of Japan	B29C	15/00	X	

OTHER DOCUMENTS (Including Authors, Title, Date, Pertinent Papers, etc.)

MPV		"Coolstream LSTF, The Future is 'Gentle Touch' Fusing", Bandwise Reliant Ltd., Buckinghamshire HP5 2PY UK, May 1997

EXAMINER*M. Vargst***Date Considered**

9/15/03

*Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

Based on Form PTO-FB-A820
(Also form PTO-1449)
document4 4/1/99

Patent and Trademark Office, U.S. Department of Commerce

